

N-Channel Super Trench Power MOSFET

Description

The RM120N60T2 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

V_{DS} =60V,I_D =120A

 $R_{DS(ON)} < 4.0m\Omega @ V_{GS}=10V$ (Typ:3.5m Ω) $R_{DS(ON)} < 5.0m\Omega @ V_{GS}=4.5V$ (Typ:4.0m Ω)

- Excellent gate charge x R_{DS(on)} product
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification
- Halogen-free

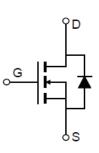
100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
120N60	RM120N60T2	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	60	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous (Silicon Limited)	Ι _D	120	А	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	100	А	
Pulsed Drain Current	I _{DM}	480	А	
Maximum Power Dissipation	PD	180	W	
Derating factor		1.2	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	500	mJ	
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C	



Schematic diagram



TO-220-3L top view

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{eJC}	0.83	°C/W
--	------------------	------	------

Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	· · ·		•			•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, I _D =250µA	1.0	1.7	2.4	V
	_	V _{GS} =10V, I _D =60A	-	3.5	4.0	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =60A	-	4.0	5.0	mΩ
Forward Transconductance	G FS	V _{DS} =10V,I _D =60A	40	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}		-	4000	-	PF
Output Capacitance	Coss	V_{DS} =30V, V_{GS} =0V,	-	680	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	23	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =60A	-	5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =4.7 Ω	-	56	-	nS
Turn-Off Fall Time	t _f		-	12	-	nS
Total Gate Charge	Qg	N/ 00)// 00A	-	67		nC
Gate-Source Charge	Q _{gs}	V_{DS} =30V,I _D =60A,	-	12		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	8.5		nC
Drain-Source Diode Characteristics			·			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =120A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	120	А
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C, I_F = I_S$	-	48		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	60		nC
				1		I

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

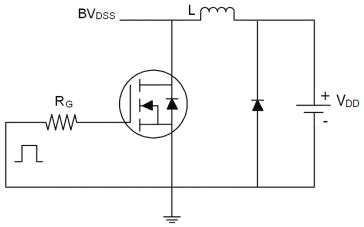
3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

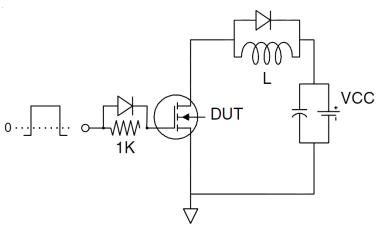
5. EAS condition : Tj=25 $^\circ \!\! \mathbb{C}$,V_DD=30V,V_G=10V,L=0.5mH,Rg=25\Omega



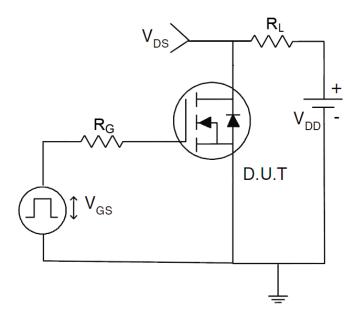
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit

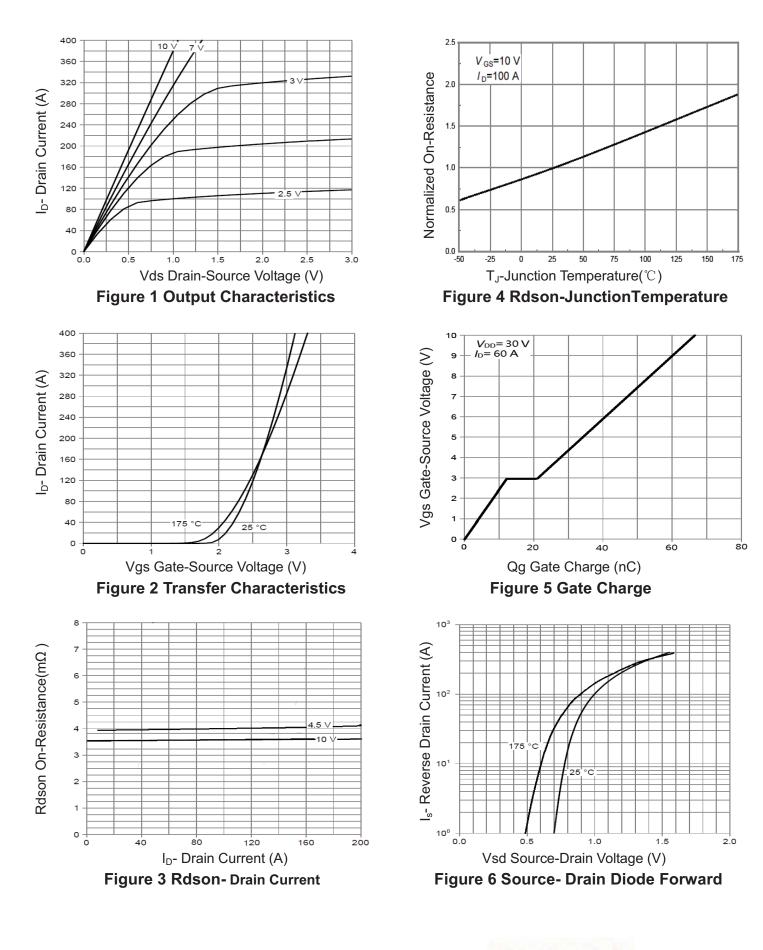


3) Switch Time Test Circuit



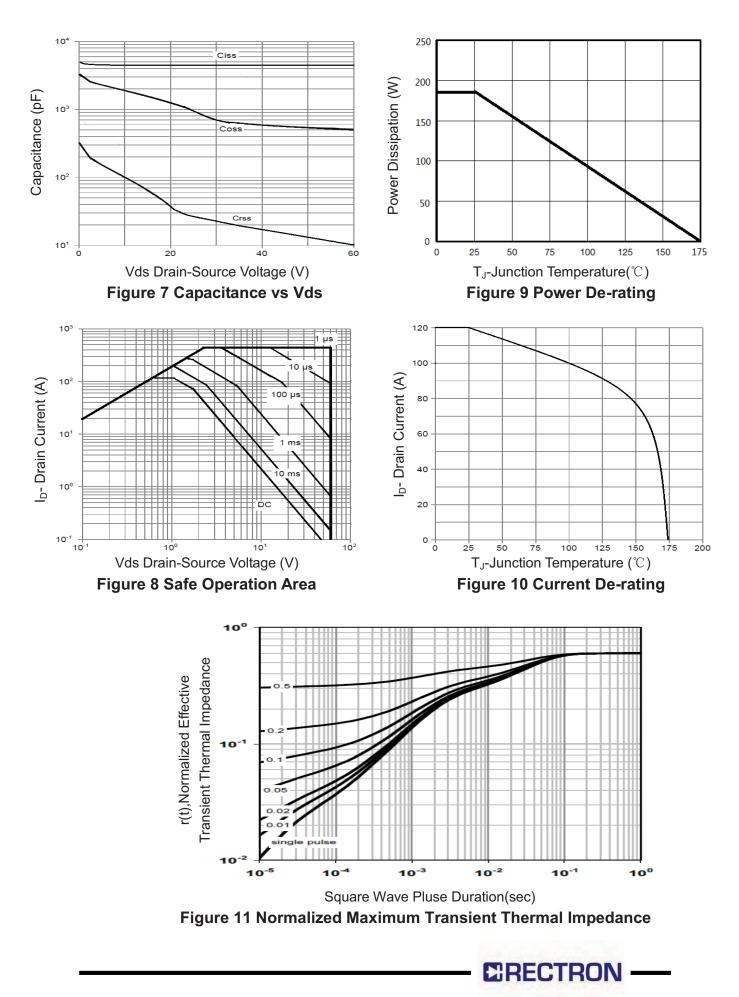


RATING AND CHARACTERISTICS CURVES (RM120N60T2)

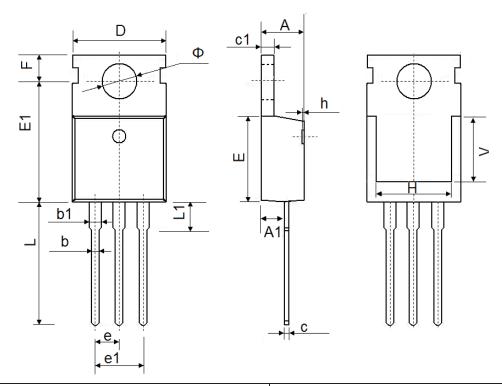




RATING AND CHARACTERISTICS CURVES (RM120N60T2)



TO-220-3L Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	7.500 REF.		REF.	
Φ	3.400	3.800	0.134	0.150	



DISCLAIMER NOTICE

Rectron Inc reserves the right to make changes without notice to any product specification herein, to make corrections, modifications, enhancements or other changes. Rectron Inc or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies. Data sheet specifications and its information contained are intended to provide a product description only. "Typical" parameters which may be included on RECTRON data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. Rectron Inc does not assume any liability arising out of the application or use of any product or circuit.

Rectron products are not designed, intended or authorized for use in medical, life-saving implant or other applications intended for life-sustaining or other related applications where a failure or malfunction of component or circuitry may directly or indirectly cause injury or threaten a life without expressed written approval of Rectron Inc. Customers using or selling Rectron components for use in such applications do so at their own risk and shall agree to fully indemnify Rectron Inc and its subsidiaries harmless against all claims, damages and expenditures.

